

## Product/Process Change Notifications



# PCN - 15 009

Release Date:    March    02    2015

<b>Product Name:</b>	ExaMAX			
	PCB			
<b>Product Manager:</b>	Stan Zhang			
<b>Subject:</b>	Notification of Change with Immediate Effectivity			
<b>Distribution:</b>	General			
<b>Type of Change:</b>	Documentation Change			
<b>Change Description:</b>	Change the Cu plating thickness of printed circuit board from 0.025-0.050um to 0.020-0.050um.			
<b>Reason for Change:</b>	FCI was requested by a specific customer to modify the recommended Cu plating thickness of printed circuit board to meet the IPC-2221A Generic standard on printed board design in order to satisfy the feasibility of PCB plating. There is no change to actual product. The change happens only recommended PCB spec.			
<b>Affected Parts:</b>	Attached list.			
<b>Effective Date of Change:</b>	March 3, 2015			
<b>Last Time Buy Date:</b>	NA			
<b>Last Disty Return Date:</b>	NA			
<b>Last Time Shipment Date</b>	NA			
<b>Datasheet Attached?</b>	Yes			
<b>Qual/Test Data Attached?</b>	NA			
<b>Samples Availability Date:</b>	March	3	2015	
<b>Available Alternatives?</b>	N/A			
<b>Questions?</b>	<i>Contact your local FCI Representative, or Product Manager</i>			
	<i>Stan Zhang/ Product manager</i>			
	<i>Stan.zhang@fci.com</i>			

**Note:**

Customer shall intimate the product Manager any Concern regarding the PCN within 3 weeks of the release date.  
 PCN is considered approved by the customer if no communication is received within 3 weeks